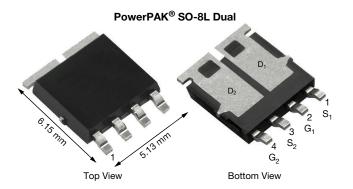
## SQJB46EP

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**Vishay Siliconix** 

# Automotive Dual N-Channel 40 V (D-S) 175 °C MOSFET



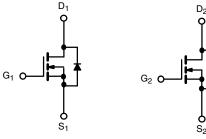
### FEATURES

- TrenchFET<sup>®</sup> Gen IV Power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>q</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS COMPLIANT HALOGEN FREE

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	40			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 V$	0.008			
I <sub>D</sub> (A)	30			
Configuration	Dual			



N-Channel MOSFET

N-Channel MOSFET

ORDERING INFORMATION			
Package	PowerPAK SO-8L		
Lead (Pb)-free and halogen-free	SQJB46EP-T1-GE3		

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	40	v	
Gate-source voltage		V <sub>GS</sub>	± 20	v	
Continuous drain current	$T_C = 25 \ ^{\circ}C \ ^{a}$	1_	30		
Continuous drain current	T <sub>C</sub> = 125 °C	Ι <sub>D</sub>	28.5		
Continuous source current (diode conduction) a		I <sub>S</sub>	30	A	
Pulsed drain current <sup>b</sup>		I <sub>DM</sub>	120		
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	21		
Single pulse avalanche energy	L = 0.1 mm	E <sub>AS</sub>	22	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C	PD	34	w	
Maximum power dissipation	T <sub>C</sub> = 125 °C	FD	11	vv	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering recommendations (peak temperature) <sup>d</sup>			260		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount <sup>c</sup>	R <sub>thJA</sub>	85	°C/W	
Junction-to-case (drain)		R <sub>thJC</sub>	4.3	0/10	

#### Notes

a. Package limited

b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

c. When mounted on 1" square PCB (FR4 material)

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leaded package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					•		
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$		40	-	-	V
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	: V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2.3	2.8	3.3	V
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	0 V, $V_{GS} = \pm 20 V$	-	-	± 100	nA
-		V <sub>GS</sub> = 0 V V <sub>DS</sub> = 40 V		-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V, T <sub>J</sub> = 125 °C	-	-	50	μA
		$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V, T <sub>J</sub> = 175 °C	-	-	250	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 V$	25	-	-	Α
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 8 A	-	0.0061	0.0080	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 8 A, T <sub>J</sub> = 125 °C	-	-	0.0117	Ω
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 8 A, T <sub>J</sub> = 175 °C	-	-	0.0136	
Forward transconductance b	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 8 A		-	34	-	S
Dynamic <sup>b</sup>	-	•		•		•	
Input capacitance	C <sub>iss</sub>		V <sub>DS</sub> = 25 V, f = 1 MHz	-	1268	1800	pF
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		-	428	600	
Reverse transfer capacitance	C <sub>rss</sub>			-	32	45	
Total gate charge <sup>c</sup>	Qg			-	21	32	
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	$V_{GS} = 10 V$	$V_{DS} = 20 V, I_D = 3 A$	-	5.8	-	nC
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>			-	4.5	-	
Gate resistance	R <sub>g</sub>	f = 1 MHz		1.26	2.54	3.8	Ω
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>			-	12	20	
Rise time <sup>c</sup>	tr		$V_{DD} = 20 \text{ V}, \text{ R}_{\text{I}} = 6.67 \Omega$		5	10	ns
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong \overline{3} \text{ A}, V_{GEN} = \overline{10} \text{ V}, \text{ R}_g = 1 \Omega$		-	19	30	
Fall time <sup>c</sup>	t <sub>f</sub>			-	6	12	
Source-Drain Diode Ratings and Chara	acteristics <sup>b</sup>						
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	120	Α
Forward voltage	V <sub>SD</sub>	$I_{F} = 8 \text{ A}, V_{GS} = 0 \text{ V}$		-	0.8	1.2	V
Body diode reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 6 A, di/dt = 100 A/μs		-	26	55	ns
Body diode reverse recovery charge	Q <sub>rr</sub>			-	16	35	nC
Reverse recovery fall time	t <sub>a</sub>			13	-	200	
Reverse recovery rise time	t <sub>b</sub>		1		13	-	ns
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	-1.024	-	А

#### Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

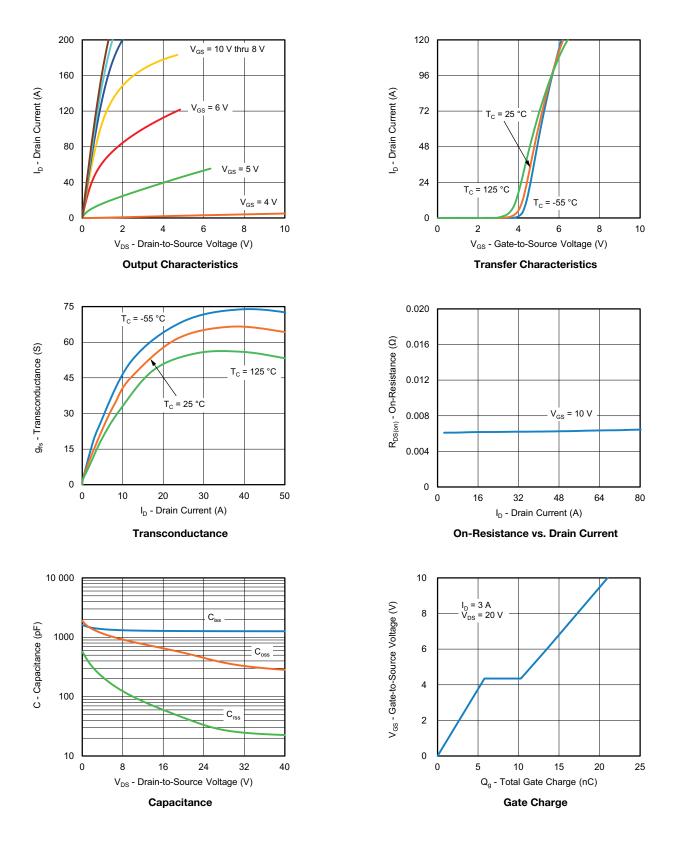
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



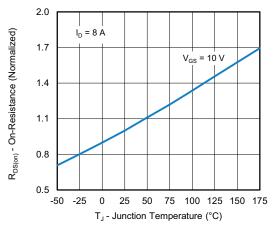
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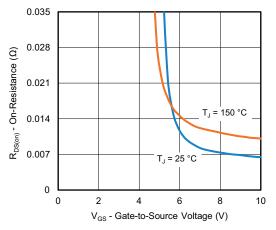


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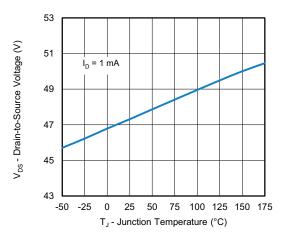
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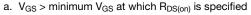
**On-Resistance vs. Junction Temperature** 

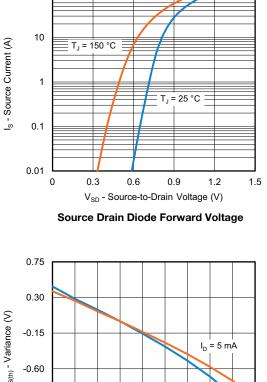


**On-Resistance vs. Gate-to-Source Voltage** 

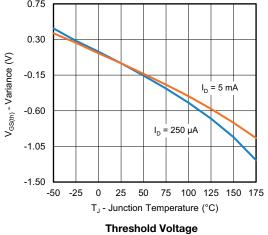


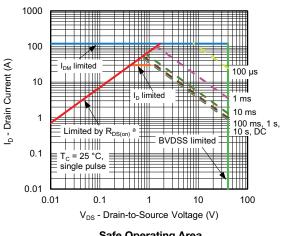
Drain Source Breakdown vs. Junction Temperature Note





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Safe Operating Area

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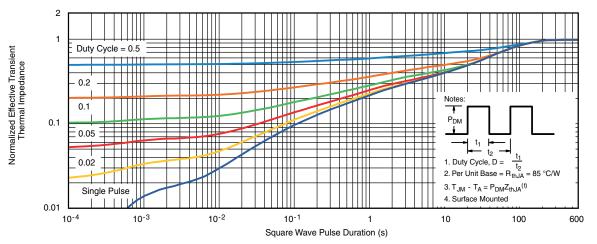
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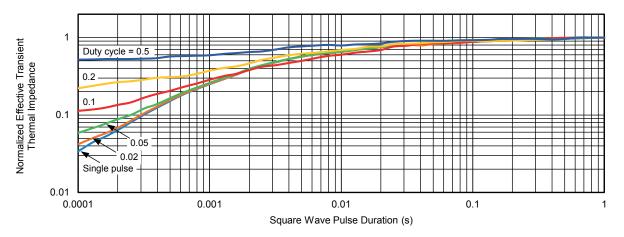


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### **THERMAL RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

- The characteristics shown in the two graphs
- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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